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August 2008

HCPL3700 AC/DC to Logic Interface Optocoupler

Features

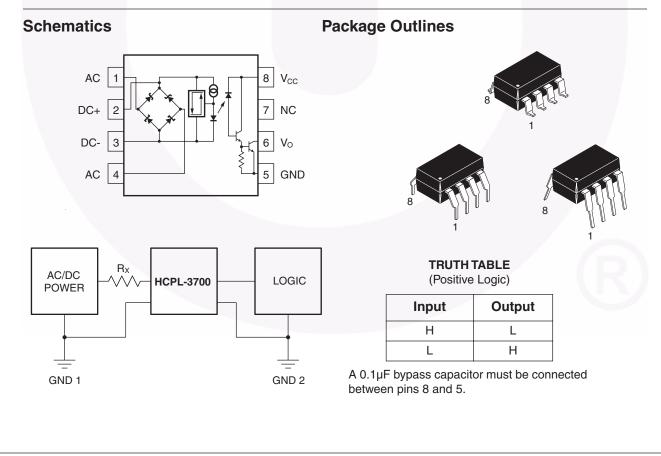
- AC or DC input
- Programmable sense voltage
- Logic level compatibility
- Threshold guaranteed over temperature (0°C to 70°C)
- Optoplanar[™] construction for high common mode immunity
- UL recognized (file # E90700)
- VDE certified ordering option 'V', e.g., HCPL3700V

Applications

- Low voltage detection
- 5 V to 240 V AC/DC voltage sensing
- Relay contact monitor
- Current sensing
- Microprocessor Interface
- Industrial controls

Description

The HCPL-3700 voltage/current threshold detection optocoupler consists of an AlGaAs LED connected to a threshold sensing input buffer IC which are optically coupled to a high gain darlington output. The input buffer chip is capable of controlling threshold levels over a wide range of input voltages with a single resistor. The output is TTL and CMOS compatible.



Absolute Maximum Ratings (No derating required up to 70°C)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol		Parameter	Value	Units
T _{STG}	Storage Temperature		-55 to +125	°C
T _{OPR}	Operating Temper	ature	-40 to +85	°C
T _{SOL}	Lead Solder Temp	perature	260 for 10 sec	°C
EMITTER				
I _{IN}	Input Current	Average	50 (Max.)	mA
		Surge, 3ms, 120Hz Pulse Rate	140 (Max.)	
		Transient, 10µs, 120Hz Pulse Rate	500 (Max.)	
V _{IN}	Input Voltage (Pins 2-3)		-0.5 (Max.)	V
P _{IN}	Input Power Dissipation ⁽¹⁾		230 (Max.)	mW
PT	Total Package Power Dissipation ⁽²⁾		305 (Max.)	mW
DETECTOR	1			
Ι _Ο	Output Current (Average) ⁽³⁾		30 (Max.)	mA
V _{CC}	Supply Voltage (P	Supply Voltage (Pins 8-5)		V
Vo	Output Voltage (P	Output Voltage (Pins 6-5)		V
Po	Output Power Dis	sipation ⁽⁴⁾	210 (Max.)	mW

Notes:

1. Derate linearly above 70°C free-air temperature at a rate of 1.8 mW/°C.

2. Derate linearly above 70°C free-air temperature at a rate of 2.5 mW/°C.

3. Derate linearly above 70°C free-air temperature at a rate of 0.6 mA/°C.

4. Derate linearly above 70°C free-air temperature at a rate of 1.9 mW/°C.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V _{CC}	Supply Voltage	2	18	V
T _A	Operating Temperature	0	70	°C
f	Operating Frequency	0	4	kHz

Symbol	Parame	ter	Test Conditions	Min.	Тур.	Max.	Unit
I _{TH+}	Input Threshold Cu	urrent	$V_{IN} = V_{TH+}, V_{CC} = 4.5 V$	1.96	2.4	3.11	mA
I _{TH-}	7		$V_{O} = 0.4 \text{ V}, I_{O} \ge 4.2 \text{mA}^{(5)}$	1.00	1.2	1.62	mA
V_{TH+}	Input Threshold Voltage	DC (Pins 2,3)	$\begin{array}{l} V_{IN} = V_2 - V_3 \; (\text{Pins 1 \& 4 Open}) \\ V_{CC} = 4.5 \; \text{V}, V_O = 0.4 V^{(5)} \\ I_O \geq 4.2 \text{mA} \end{array}$	3.35	3.8	4.05	V
V _{TH-}			$ \begin{array}{l} V_{IN} = V_2 - V_3 \; (\text{Pins 1 \& 4 Open}) \\ V_{CC} = 4.5 \; \text{V}, V_O = 2.4 \; \text{V}^{(5)} \\ I_O \geq 100 \mu \text{A} \end{array} $	2.01	2.5	2.86	V
V _{TH+}		AC (Pins 1,4)		4.23	5.0	5.50	V
V _{TH-}				2.87	3.7	4.20	V
I _{HYS}	Hysteresis		$I_{HYS} = I_{TH+} - I_{TH-}$		1.2		mA
V _{HYS}			$V_{HYS} = V_{TH+} - V_{TH-}$		1.3		V
V _{IHC1}	Input Clamp Voltage		$V_{IHC1} = V_2 - V_3, V_3 = GND$ $I_{IN} = 10 \text{ mA},$ Pins 1 & 4 connected to Pin 3	5.4	6.3	6.6	V
V _{IHC2}			$V_{IHC2} = V_1 - V_4 , I_{IN} = 10mA$ (Pins 2 & 3 Open)	6.1	7.0	7.3	V
V _{IHC3}			$V_{IHC3} = V_2 - V_3, V_3 = GND,$ $I_{IN} = 15mA$ (Pins 1 & 4 Open)		12.5	13.4	V
V _{ILC}			$V_{ILC} = V_2 - V_3, V_3 = GND,$ $I_{IN} = -10mA$		-0.75		V
I _{IN}	Input Current		$V_{IN} = V_2 - V_3 = 5.0V$ (Pins 1 & 4 Open)	3.0	3.7	4.4	mA
V _{D1,2}	Bridge Diode		I _{IN} = 3mA		0.65		V
V _{D3,4}	Forward Voltage		I _{IN} = 3mA		0.65		V
V _{OL}	Logic LOW Output Voltage		$V_{CC} = 4.5 \text{ V}, \text{ I}_{OL} = 4.2 \text{mA}^{(5)}$		0.04	0.4	V
I _{OH}	Logic HIGH Output Current		$V_{OH} = V_{CC} = 18V^{(5)}$			100	μA
ICCL	Logic LOW Supply Current		V_2-V_3 = 5.0V, V_O = Open, V_{CC} = 5V		1.0	4	mA
I _{CCH}	Logic HIGH Supply	y Current	V _{CC} = 18V, V _O = Open		0.01	4	μA
C _{IN}	Input Capacitance		f = 1MHz, V _{IN} = 0V (Pins 2 & 3, Pins 1 & 4 Open)		50		pF

Note:

5. Logic LOW output level at pin 6 occurs when $V_{IN} \ge V_{TH+}$ and when $V_{IN} > V_{TH-}$ once V_{IN} exceeds V_{TH+} . Logic HIGH output level at pin 6 occurs when $V_{IN} \le V_{TH-}$ and when $V_{IN} < V_{TH+}$ once V_{IN} decreases below V_{TH-} .

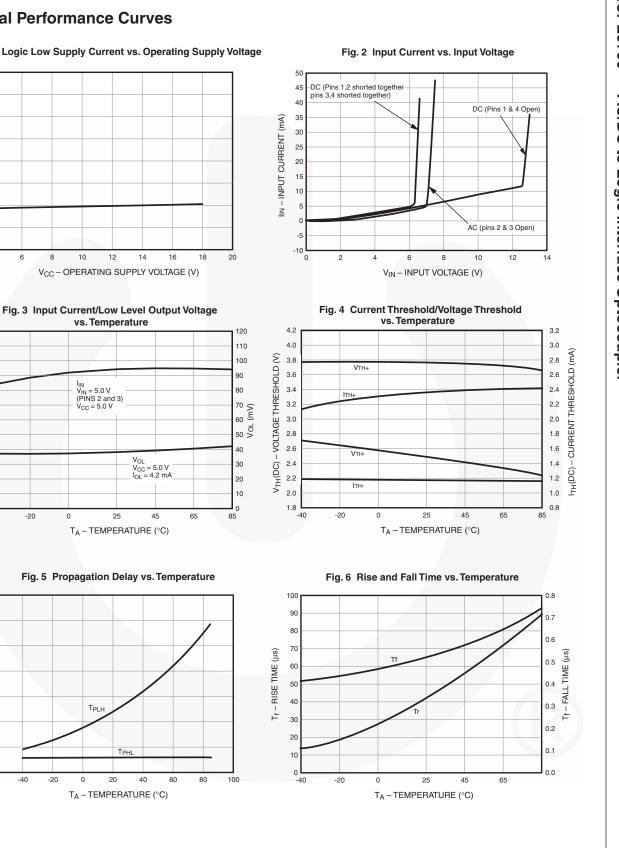
Symbol	AC Characteristics	Test Conditions	Min.	Тур.	Max.	Unit
T _{PHL}	Propagation Delay Time (to Output Low Level)	$R_L = 4.7 k\Omega, C_L = 30 p F^{(6)}$		6.0	15	μs
T _{PLH}	Propagation Delay Time (to Output High Level)	$R_L = 4.7 k\Omega, C_L = 30 p F^{(6)}$		25.0	40	μs
t _r	Output Rise Time (10–90%)	$R_L = 4.7 k\Omega, C_L = 30 pF$		45		μs
t _f	Output Fall Time (90–10%)	$R_L = 4.7 k\Omega, C_L = 30 pF$		0.5		μs
ICM _H I	Common Mode Transient Immunity (at Output High Level)	$\begin{split} I_{IN} &= 0 \text{ mA}, \text{ R}_L = 4.7 \text{k}\Omega, \\ V_{O \text{ min}} &= 2.0 \text{ V}, \text{ V}_{CM} = 1400 \text{V}^{(7)(8)} \end{split}$		4000		V/µs
ICM _L I	Common Mode Transient Immunity (at Output Low Level)	$\begin{split} I_N &= 3.11 \text{mA}, \ R_L = 4.7 \text{k}\Omega, \\ V_O & \text{max} = 0.8 \text{V}, \ V_{CM} = 140 \text{V}^{(7)(8)} \end{split}$		600		V/µs

Package Characteristics (T_A = 0°C to 70°C Unless otherwise specified)

Symbol	Characteristics	Test Conditions	Min.	Тур.	Max.	Unit
V _{ISO}	Withstand Insulation Voltage	$ \begin{array}{l} \mbox{Relative humidity} < 50\%, \\ \mbox{T}_A = 25^\circ\mbox{C}, t = 1 \mbox{ min}, \\ \mbox{I}_{I\text{-O}} \leq 2\mu A^{(9)(10)} \end{array} $	2500			V _{RMS}
R _{I-O}	Resistance (input to output)	$V_{IO} = 500 V dc^{(9)}$		10 ¹²		Ω
C _{I-O}	Capacitance (input to output)	$f = 1MHz, V_{IO} = 0Vdc$		0.6		pF

Notes:

- T_{PHL} propagation delay is measured from the 2.5V level of the leading edge of a 5.0V input pulse (1µs rise time) to the 1.5 V level on the leading edge of the output pulse. T_{PLH} propagation delay is measured on the trailing edges of the input and output pulse. (Refer to Fig. 9)
- 7. Common mode transient immunity in logic high level is the maximum tolerable (positive) dV_{cm}/dt on the leading edge of the common mode pulse signal V_{CM} , to assure that the output will remain in a logic high state (i.e., $V_O > 2.0 V$). Common mode transient immunity in logic low level is the maximum tolerable (negative) dV_{cm}/dt on the trailing edge of the common mode pulse signal, V_{CM} , to assure that the output will remain in a logic low state (i.e., $V_O < 0.8 V$). Refer to Fig. 10.
- In applications where dV_{cm}/dt may exceed 50,000 V/µs (Such as static discharge), a series resistor, R_{CC}, should be included to protect the detector chip from destructive surge currents. The recommended value for R_{CC} is 240V per volt of allowable drop in V_{CC} (between pin 8 and V_{CC}) with a minimum value of 240Ω.
- 9. Device is considered a two terminal device: Pins 1, 2, 3 and 4 are shorted together and Pins 5, 6, 7 and 8 are shorted together.
- 10. The 2500 V_{RMS}/1 min. capability is validated by a 3.0 kV_{RMS}/1 sec. dielectric voltage withstand test.
- 11. AC voltage is instantaneous voltage for V_{TH+} & V_{TH-} .
- 12. All typicals at $T_A = 25^{\circ}$ C, $V_{CC} = 5$ V unless otherwise specified.



Typical Performance Curves

4.0

3.5

3.0

2.5

2.0

1.5

1.0

0.5

0.0

4.2

4.0

3.8

3.6

3.4

3.2

3.0

2.8

2.6

2.4

2.2

2.0

1.8

70

60

50

40

30

20

10

0 L -60

 T_P – PROPAGATION DELAY (μs)

-40

-20

0

I_{IN} – INPUT CURRENT (mA)

4

6

8

10

12

 $\begin{array}{l} I_{IN} \\ V_{IN} = 5.0 \ V \\ (PINS \ 2 \ and \ 3) \\ V_{CC} = 5.0 \ V \end{array}$

25

T_{PLH}

0

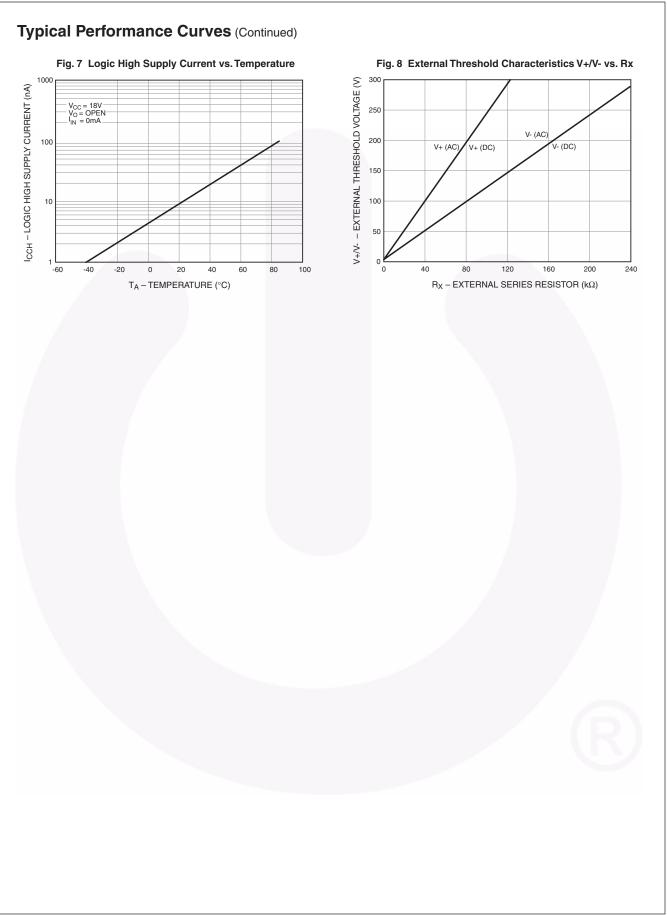
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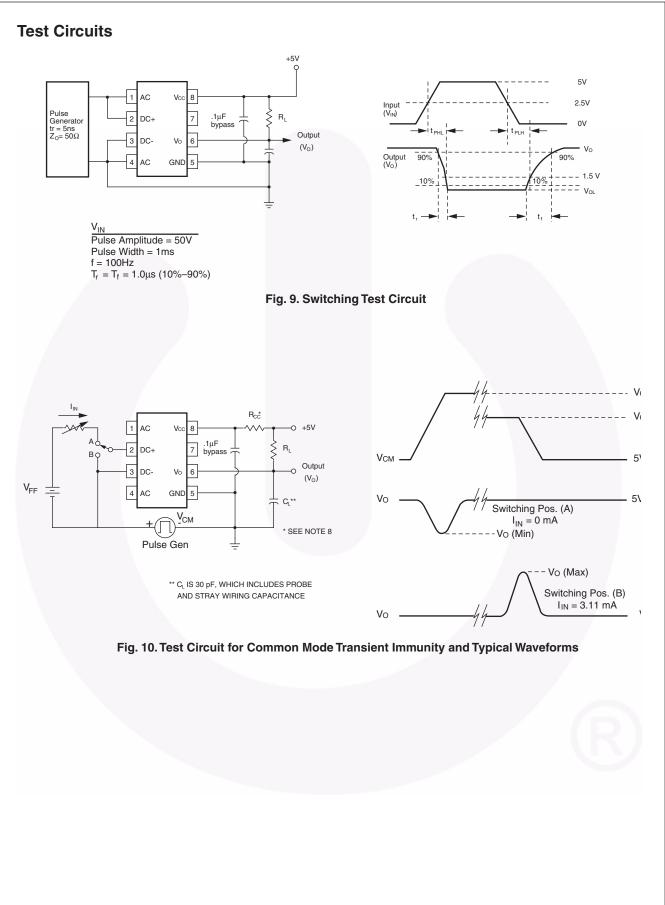
I_{CCL} – LOGIC LOW SUPPLY CURRENT (mA)

Fig. 1 Logic Low Supply Current vs. Operating Supply Voltage

-40

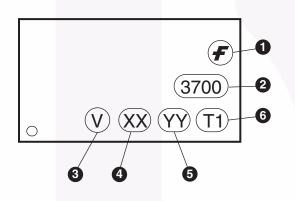
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Ordering Information	dering Information					
Option	Example Part Number	Description				
No Suffix	HCPL3700	Shipped in Tubes				
S	HCPL3700S	Surface Mount Lead Bend				
SD	HCPL3700SD	Surface Mount; Tape and Reel				
W	HCPL3700W	0.4" Lead Spacing				
V	HCPL3700V	VDE0884				
WV	HCPL3700WV	VDE0884; 0.4" Lead Spacing				
SV	HCPL3700SV	VDE0884; Surface Mount				
SDV	HCPL3700SDV	VDE0884; Surface Mount; Tape and Reel				

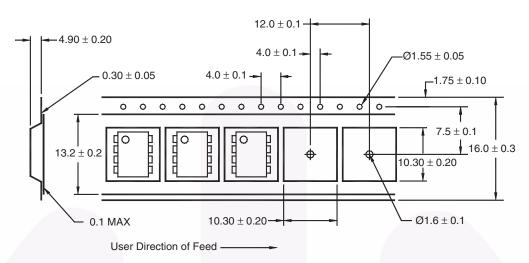
Marking Information



Definitions				
1	Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	Two digit year code, e.g., '07'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			



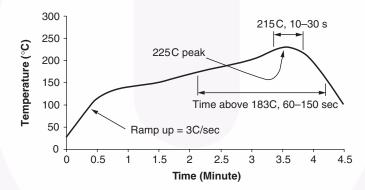
Carrier Tape Specifications



Note:

All dimensions are in inches (millimeters)

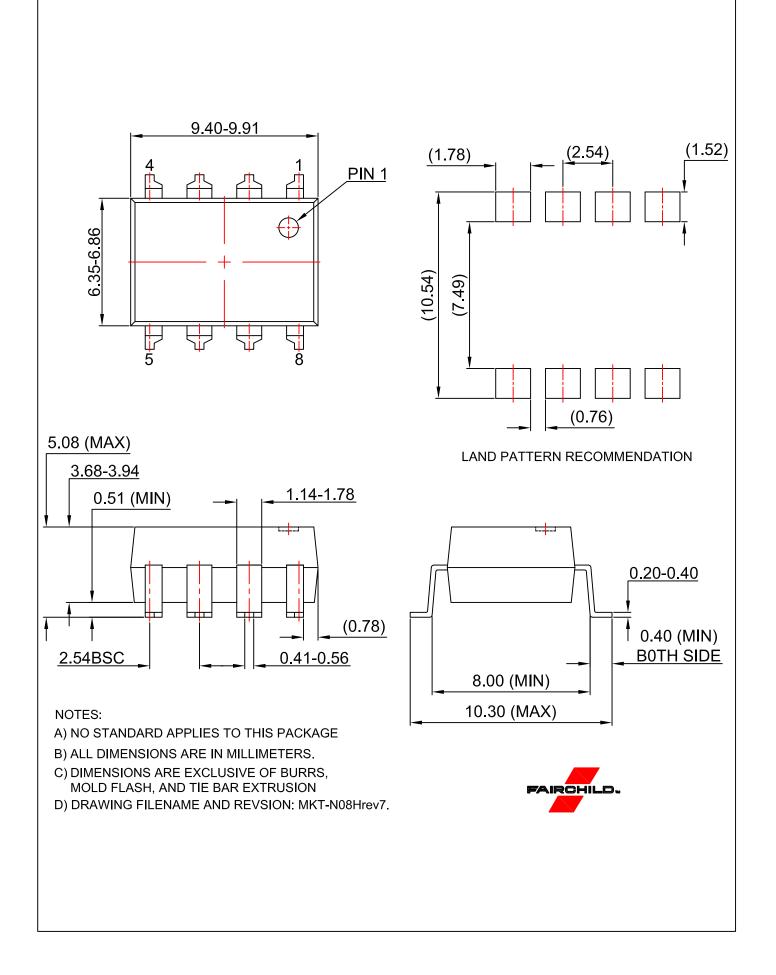
Reflow Profile



Peak reflow temperature: 225C (package surface temperature) Time of temperature higher than 183C for 60–150 seconds One time soldering reflow is recommended ٠

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